

MOSFETs Silicon N-Channel MOS (U-MOSVII)

TPCC8076

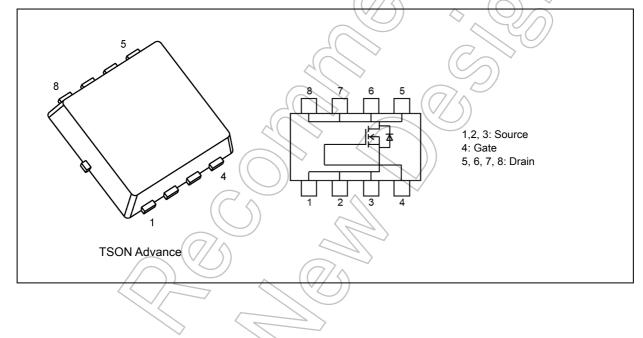
1. Applications

- · Lithium-Ion Secondary Batteries
- · Notebook PCs
- · Mobile Equipments

2. Features

- (1) Small footprint due to a small and thin package
- (2) Low drain-source on-resistance: $R_{DS(ON)} = 3.7 \text{ m}\Omega$ (typ.) ($V_{GS} = 10 \text{ V}$)
- (3) Low leakage current: I_{DSS} = 10 μA (max) (V_{DS} = 33 V)
- (4) Enhancement mode: $V_{th} = 1.3$ to 2.3 V ($V_{DS} = 10$ V, $I_D = 0.3$ mA)

3. Packaging and Internal Circuit



Start of commercial production



4. Absolute Maximum Ratings (Note) (Ta = 25°C unless otherwise specified)

Characteri	stics		Symbol	Rating	Unit
Drain-source voltage			V _{DSS}	33	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)		(Note 1)	I _D	27	Α
Drain current (pulsed)		(Note 1)	I _{DP}	81	
Power dissipation	(T _c = 25 °C)		P _D	39	W
Power dissipation	(t = 10 s)	(Note 2)	P _D	1.9	
Power dissipation	(t = 10 s)	(Note 3)	Pp	0.7	W
Single-pulse avalanche energy		(Note 4)	Eas)) 82	mJ
Avalanche current			HAR	27	Α
Channel temperature			(T _{ch})	150	°C
Storage temperature		6	T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

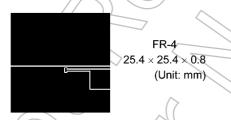
C	haracteristics		Symbol	Max	Unit
Channel-to-case thermal resistance	(T _c = 25 °C)		R _{th(ch-c)}	3.2	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 2)	R _{th(ch-a)}	65.7	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	R _{th(ch-a)}	178	°C/W

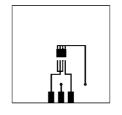
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 0.1 mH, R_G = 1 Ω , I_{AR} = 27 A





 $FR-4 \\ 25.4 \times 25.4 \times 0.8 \\ \text{(Unit: mm)}$

Fig. 5.1 Device Mounted on a Glass-Epoxy
Board (a)

Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ
Drain cut-off current	I _{DSS}	V _{DS} = 33 V, V _{GS} = 0 V		_	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	33			V
	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	18)		
Gate threshold voltage	V_{th}	V _{DS} = 10 V, I _D = 0.3 mA	1.3	<i>7</i> _	2.3	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 4.5 V, I _D = 13.5 A	/ A	4.9	6.2	mΩ
		V _{GS} = 10 V, I _D = 13.5 A		3.7	4.6	

6.2. Dynamic Characteristics (T_a = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		2500		pF
Reverse transfer capacitance	C _{rss}	((// \) \ \	_((120		
Output capacitance	C _{oss}		K	430) —	
Switching time (rise time)	t _r	See Figure 6.2.1.		2.9		ns
Switching time (turn-on time)	t _{on}			10		
Switching time (fall time)	t _f			9.5		
Switching time (turn-off time)	t _{off}		$\widetilde{\bigcirc}$	48		

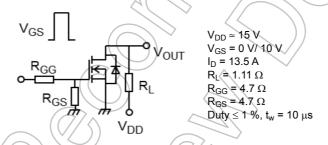


Fig. 6.2.1 Switching Time (Fig.)

6.3. Gate Charge Characteristics (Ta = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD} \approx 24 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 27 \text{ A}$	_	34	_	nC
Gate-source charge 1	Q _{gs1}			7.4	_	
Gate-drain charge	Q_{gd}		_	4	_	

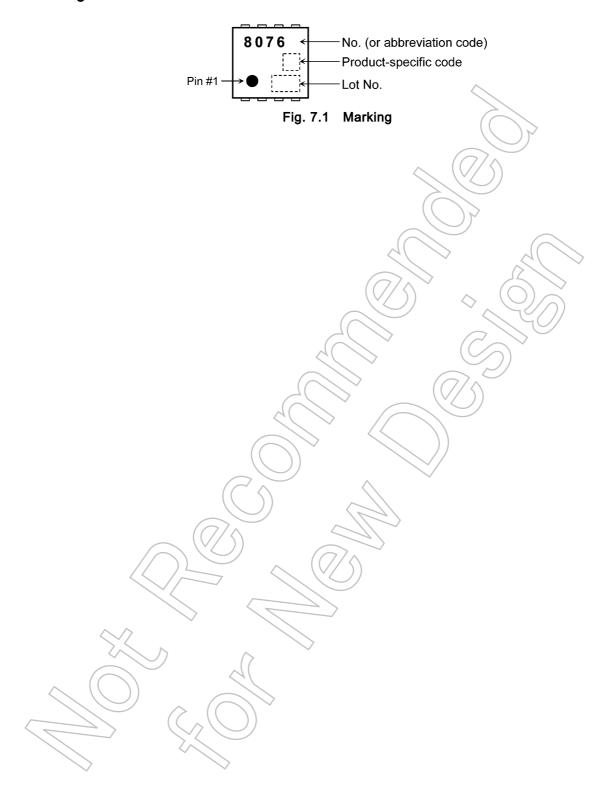
6.4. Source-Drain Characteristics (T_a = 25°C unless otherwise specified)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed)	(Note 5)	I _{DRP}	_	_		81	Α
Diode forward voltage		V_{DSF}	I _{DR} = 27 A, V _{GS} = 0 V			-1.2	V

Note 5: Ensure that the channel temperature does not exceed 150°C.



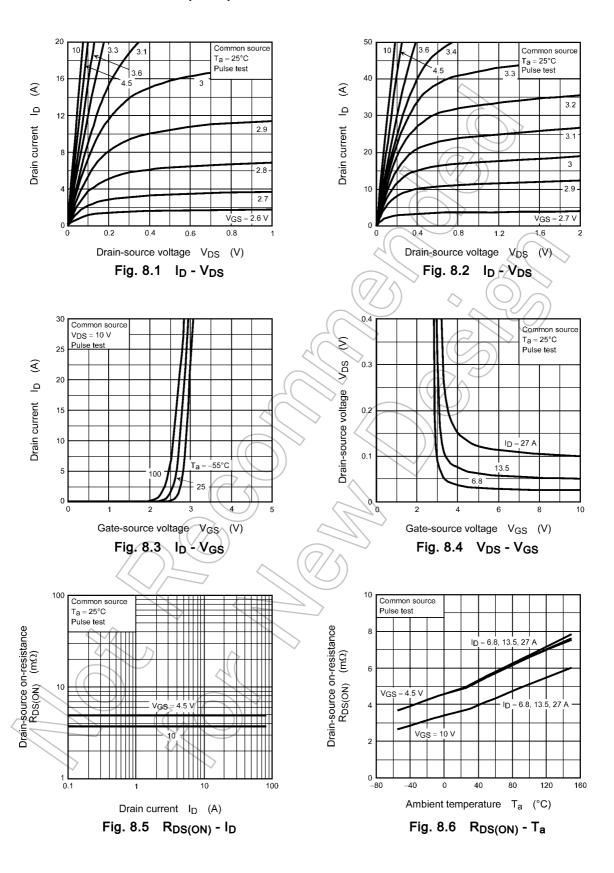
7. Marking



Rev.4.0



8. Characteristics Curves (Note)





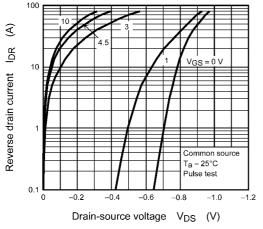


Fig. 8.7 IDR - VDS

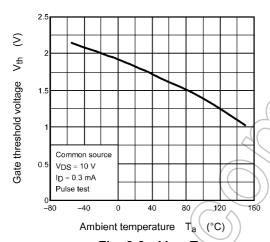


Fig. 8.9 V_{th} - T_a

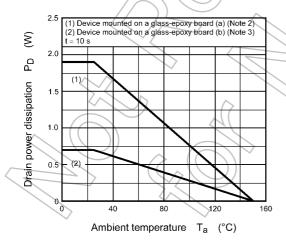


Fig. 8.11 P_D - T_a (Guaranteed Maximum)

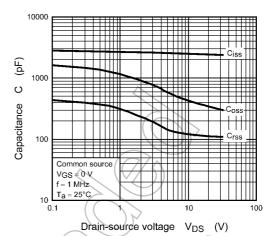


Fig. 8.8 Capacitance - VDS

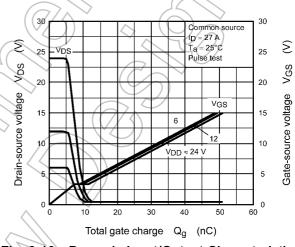


Fig. 8.10 Dynamic Input/Output Characteristics

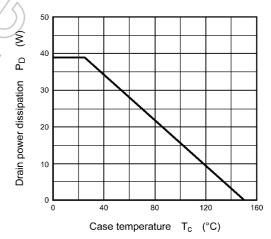
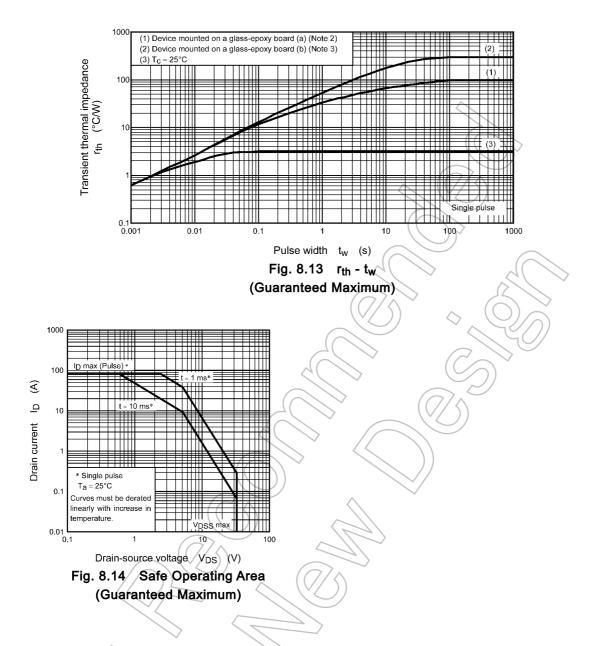


Fig. 8.12 P_D - T_c (Guaranteed Maximum)



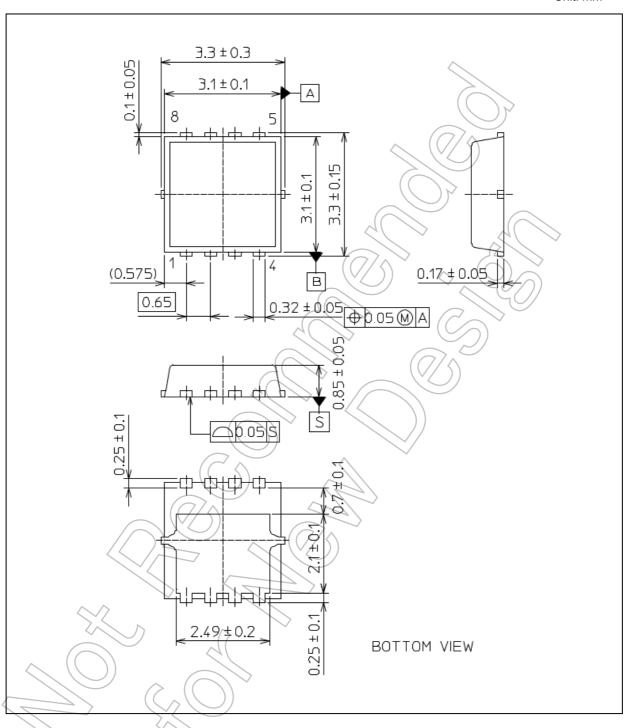


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.02 g (typ.)

Package Name(s)
TOSHIBA: 2-3X1S
Nickname: TSON Advance



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